

# N-Channel 800V (D-S) Super Junction Power MOSFET

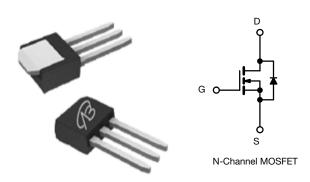
PRODUCT SUMMARY						
V <sub>DS</sub> (V) at T <sub>J</sub> max.	800					
R <sub>DS(on)</sub> typ. (Ω) at 25 °C	V <sub>GS</sub> = 10 V	1.100				

#### **FEATURES**

- Low figure-of-merit (FOM) Ron x Qa
- Low input capacitance (Ciss)
- Reduced switching and conduction losses
- Ultra low gate charge (Qa)
- Avalanche energy rated (UIS)



### TO-251



## **APPLICATIONS**

- Server and telecom power supplies
- Switch mode power supplies (SMPS)
- Power factor correction power supplies (PFC)
- Lighting
  - High-intensity discharge (HID)
  - Fluorescent ballast lighting
- Industrial
  - Welding
  - Induction heating
  - Motor drives
  - Battery chargers
  - Renewable energy
  - Solar (PV inverters)

ABSOLUTE MAXIMUM RATINGS (T <sub>C</sub> = 25 °C, unless otherwise noted)						
PARAMETER			SYMBOL	LIMIT	UNIT	
Drain-source voltage			$V_{DS}$	800	V	
Gate-source voltage			$V_{GS}$	± 30	V	
Continuous drain current (T, = 150 °C)	V at 10 V	$T_C = 25 ^{\circ}C$ $T_C = 100 ^{\circ}C$	_	5		
Continuous drain current (1) = 150 C)	V <sub>GS</sub> at 10 V	T <sub>C</sub> = 100 °C	I <sub>D</sub>	3	Α	
Pulsed drain current <sup>a</sup>			I <sub>DM</sub>	15		
Linear derating factor				1.7	W/°C	
Single pulse avalanche energy b			E <sub>AS</sub>	350	mJ	
Maximum power dissipation			$P_{D}$	190	W	
Operating junction and storage temperature range			T <sub>J</sub> , T <sub>stg</sub>	-55 to +150	°C	
Drain-source voltage slope T <sub>J</sub> = 125 °C		dV/dt	50	V/ns		
Reverse diode dV/dt <sup>d</sup>			5.1	V/115		
Soldering recommendations (peak temperature) c For 10 s			260	°C		

#### Notes

- a. Repetitive rating; pulse width limited by maximum junction temperature
- b.  $V_{DD}$  = 100 V, starting  $T_J$  = 25 °C, L = 30 mH,  $R_g$  = 25  $\Omega$ ,  $I_{AS}$  = 8.0 A
- c. 1.6 mm from case
- d.  $I_{SD} \le I_D$ ,  $dI/dt = 100 \text{ A/}\mu\text{s}$ , starting  $T_J = 25 \text{ °C}$

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THERMAL RESISTANCE RATINGS					
PARAMETER	SYMBOL	TYP.	MAX.	UNIT	
Maximum junction-to-ambient	$R_{thJA}$	-	62	°C/W	
Maximum junction-to-case (drain)	$R_{thJC}$	-	0.65	G/ VV	

PARAMETER	SYMBOL	TEST CONDITIONS		MIN.	TYP.	MAX.	UNIT
Static						•	
Drain-source breakdown voltage	V <sub>DS</sub>	V <sub>GS</sub> = 0 V, I <sub>D</sub> = 250 μA		800	-	-	V
V <sub>DS</sub> temperature coefficient	$\Delta V_{DS}/T_{J}$	Referenc	e to 25 °C, I <sub>D</sub> = 1 mA	-	1.08	-	V/°C
Gate-source threshold Voltage (N)	V <sub>GS(th)</sub>	V <sub>DS</sub> =	= V <sub>GS</sub> , I <sub>D</sub> = 250 μA	2.0	-	4.0	V
Oale as a salada a		$V_{GS} = \pm 20 \text{ V}$		-	-	± 100	nA
Gate-source leakage	I <sub>GSS</sub>		V <sub>GS</sub> = ± 30 V	-	-	± 1	μΑ
	_	V <sub>DS</sub> =	$V_{DS} = 800 \text{ V}, V_{GS} = 0 \text{ V}$		-	1	
Zero gate voltage drain current	I <sub>DSS</sub>	V <sub>DS</sub> = 640 \	/, V <sub>GS</sub> = 0 V, T <sub>J</sub> = 125 °C	-	-	10	μA
Drain-source on-state resistance	R <sub>DS(on)</sub>	V <sub>GS</sub> = 10 V	I <sub>D</sub> =1.5 A	-	1.100	-	Ω
Forward transconductance	9 <sub>fs</sub>	V <sub>DS</sub>	= 30 V, I <sub>D</sub> = 1.5 A	-	8.7	-	S
Dynamic							<u> </u>
Input capacitance	C <sub>iss</sub>		V <sub>GS</sub> = 0 V,	-	2300	-	
Output capacitance	C <sub>oss</sub>	1	$V_{DS} = 0 V,$ $V_{DS} = 100 V,$	-	81	-	1
Reverse transfer capacitance	C <sub>rss</sub>		f = 1 MHz		9	-	1
Effective output capacitance, energy related <sup>a</sup>	C <sub>o(er)</sub>			-	58	-	pF
Effective output capacitance, time related <sup>b</sup>	C <sub>o(tr)</sub>	$V_{DS} = 0.1$	$V_{DS} = 0 \text{ V to } 480 \text{ V}, V_{GS} = 0 \text{ V}$		296	-	
Total gate charge	Qg			-	54	122	
Gate-source charge	Q <sub>gs</sub>	V <sub>GS</sub> = 10 V	V <sub>GS</sub> = 10 V I <sub>D</sub> = 5 A, V <sub>DS</sub> = 480 V		16	-	nC
Gate-drain charge	Q <sub>gd</sub>			-	20	-	
Turn-on delay time	t <sub>d(on)</sub>	V <sub>DD</sub> = 480 V, I <sub>D</sub> = 5 A,		-	22	44	
Rise time	t <sub>r</sub>			-	24	48	
Turn-off delay time	t <sub>d(off)</sub>	V <sub>GS</sub>	$V_{DD} = 480 \text{ V}, I_D = 5 \text{ A},$ $V_{GS} = 10 \text{ V}, R_a = 9.1 \Omega$		71	142	ns
Fall time	t <sub>f</sub>			-	26	52	
Gate input resistance	$R_g$	f = 1 MHz, open drain		0.3	0.7	1.4	Ω
Drain-Source Body Diode Characteristic	s					•	
Continuous source-drain diode current	I <sub>S</sub>	MOSFET symbol showing the integral reverse p - n junction diode		-	-	5	
Pulsed diode forward current	I <sub>SM</sub>			-	-	15	A
Diode forward voltage	V <sub>SD</sub>	T <sub>J</sub> = 25 °C, I <sub>S</sub> = 5 A, V <sub>GS</sub> = 0 V		-	-	1.2	V
Reverse recovery time	t <sub>rr</sub>	$T_J = 25 \text{ °C}, I_F = I_S = 5 \text{ A},$ $dI/dt = 100 \text{ A/}\mu\text{s}, V_R = 25 \text{ V}$		-	416	832	ns
Reverse recovery charge	Q <sub>rr</sub>			-	6.4	12.8	μC
Reverse recovery current	I <sub>RRM</sub>			_	27	-	A

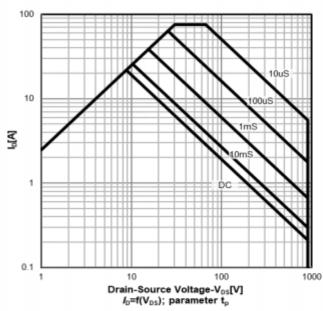
### Notes

- a.  $C_{oss(er)}$  is a fixed capacitance that gives the same energy as  $C_{oss}$  while  $V_{DS}$  is rising from 0 % to 80 %  $V_{DSS}$  b.  $C_{oss(tr)}$  is a fixed capacitance that gives the same charging time as  $C_{oss}$  while  $V_{DS}$  is rising from 0 % to 80 %  $V_{DSS}$

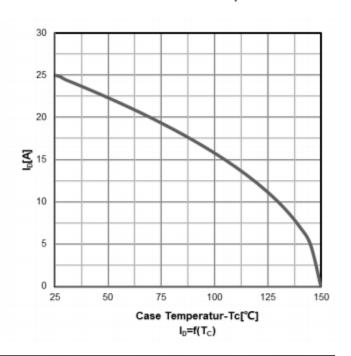


## TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

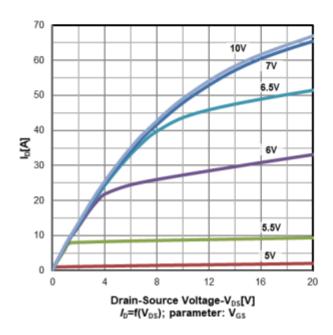
Safe operating area TC=25 °C Non FullPAK



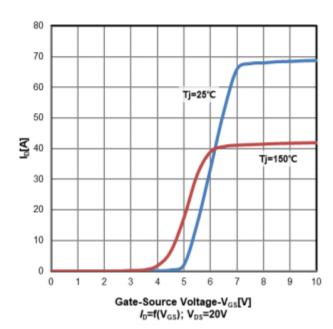
Drain current vs temperature



Typ. output characteristics  $T_j$ =25  $^{\circ}C$ 



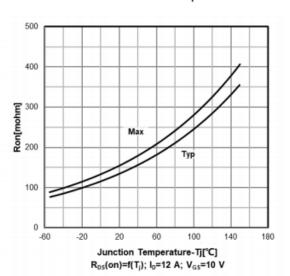
Typ. transfer characteristics



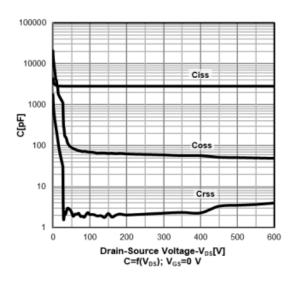


Typ. drain-source on-state resistance

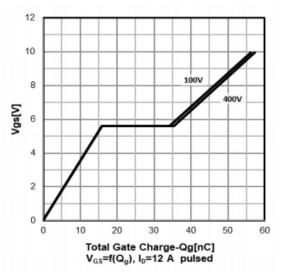
On resistance vs temperature



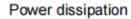
Typ. capacitances

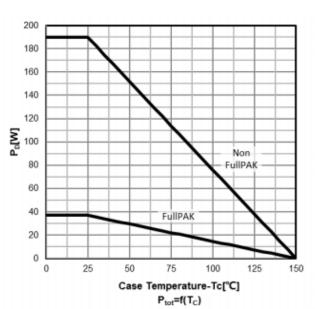


Typ. gate charge characteristics

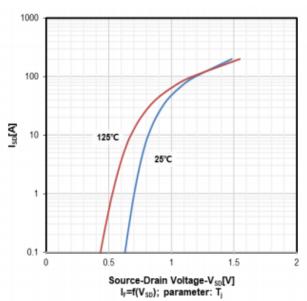




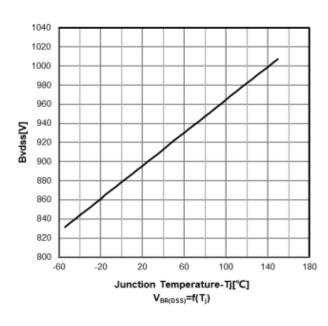




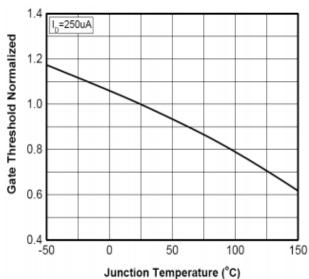
## Forward characteristics of reverse diode



## Drain-source breakdown voltage



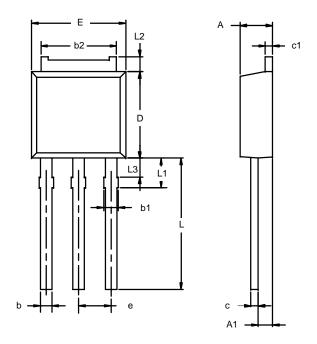
## Normalized $V_{\text{GS(th)}}$ characteristics



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Note:	Dimension	L3 is fo	or reference	only.
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	MILLIMETERS		INC	HES	
Dim	Min	Max	Min	Max	
Α	2.21	2.38	0.087	0.094	
<b>A</b> 1	0.89	1.14	0.035	0.045	
b	0.71	0.89	0.028	0.035	
b1	0.76	1.14	0.030	0.045	
b2	5.23	5.43	0.206	0.214	
С	0.46	0.58	0.018	0.023	
с1	0.46	0.58	0.018	0.023	
D	5.97	6.22	0.235	0.245	
Е	6.48	6.73	0.255	0.265	
е	2.28 BSC		0.090 BSC		
L	8.89	9.53	0.350	0.375	
L1	1.91	2.28	0.075	0.090	
L2	0.89	1.27	0.035	0.050	
L3	1.15	1.52	0.045	0.060	



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DMN2080UCB4-7 DMN61D9UWQ-13 US6M2GTR DMN31D5UDJ-7 DMP22D4UFO-7B DMN1006UCA6-7 DMN16M9UCA6-7
STF5N65M6 IRF40H233XTMA1 STU5N65M6 DMN6022SSD-13 DMN13M9UCA6-7 DMTH10H4M6SPS-13 DMN2990UFB-7B
IPB80P04P405ATMA2 2N7002W-G MCAC30N06Y-TP MCQ7328-TP NTMC083NP10M5L NVMFS2D3P04M8LT1G BXP7N65D
BXP4N65F AOL1454G WMJ80N60C4 BXP2N20L BXP2N65D BXT1150N10J BXT1700P06M TSM60NB380CP ROG RQ7L055BGTCR
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